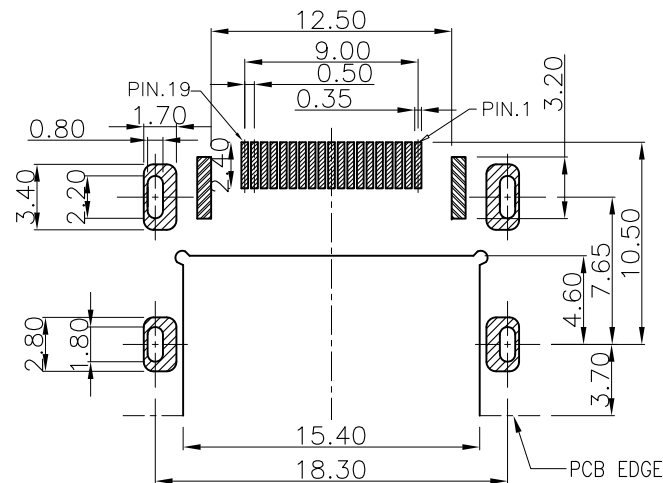
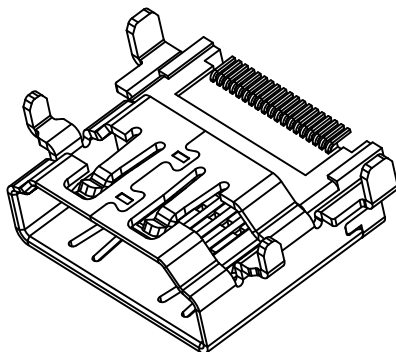
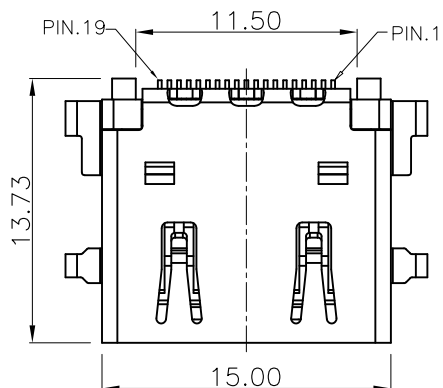
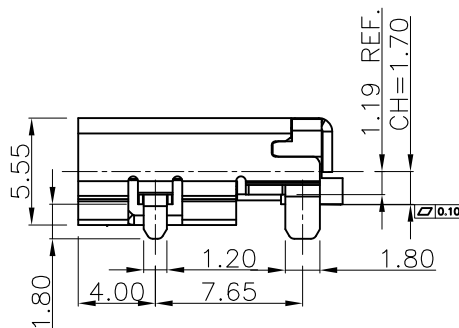
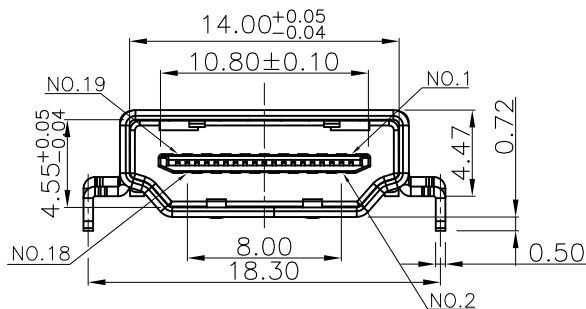


The product using material and processing must conform to the "WI-PZ-001"HSF technical standard control requirements

RoHS



RECOMMENDED PCB LAYOUT
TOP VIEW, THK=1.52MM
KEEP OUT AREA



NOTE:

1.MATERIAL:

1.1 INSULATOR:LCP E130i, COLOR:BLACK

1.2 CONTACT: C2680R/H, T=0.20MM,

1.3 SHELL:STAINLESS STEEL 304 1/4H, T=0.50MM

2. PLATING:

2.1 CONTACT: SELECTIVE GOLD PLATED ON CONTACT AREA 100u" Min. MATTE TIN PLATED ON SOLDER TAIL 50u" Min. NICKEL UNDER-PLATED

2.2 SHELL:50u" Min. NICKEL PLATED OVERALL

3. CHARACTERISTICS:

3.1 ELECTRICAL CHARACTERISTICS;

CONTACT RESISTANCE:30mΩ MAXIMUM

CONTACT CURRENT RATING:0.5A

DIELECTRIC WITHSTANDING VOLTAGE:500 V AC

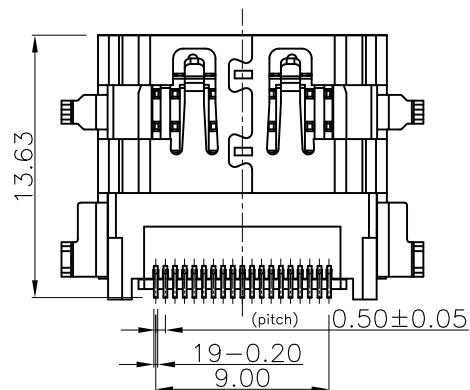
INSULATION RESISTANCE 100 MEGOHMS MIN

OPERATING TEMPERATURE:-25°C ~ +85°C

3.2 MECHANICAL:

MATING FORCE: 4.5Kg.Max.

UNMATING FORCE: 1.0-4.0Kg.Min.



WLHDF9-19 8 X X 1030

PLATING: 1-G/F
2-AU 3U"
5-AU 15U"
6-AU 30U"
COLOUR: A:Black

REV.	REVISION RECORD	DATE		GENERAL TOLERANCES		SCALE:	NAME	DATE	PART.NO:	DWG.NO:	 WanLian Teconology Co., Ltd	
A0	NEW RELEASE	21.01.13		LINEAR	ANGLES	1:1			WLHDF9-198XX1030	ENDE05		
				0.0±0.35	X°REF±6°	APPROVED	Wang_jr	21.01.13				
				0.00±0.25	X°±3°	DESIGNER	Ding_bo	21.01.13				
			UNIT:mm	0.00±0.10	X°X' ±2°	DRAWN	Ou_jian	21.01.13	TITLE: HDMI A TYPE REC, R/A SMT,LOW PROFILE CH=1.70mm		REV: A0	SHEET: 1/1